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1 Maximum ratings

Table 3 Maximum ratings

| Parameter | Symbol | Values | | | Unit | Note/Test condition |
|--|---------------|--------|------|------|------------------|---|
| | | Min. | Typ. | Max. | | |
| Continuous forward current | I_F | – | – | 6 | A | $T_C \leq 145\text{ °C}, D = 1$ |
| | | – | – | 9 | | $T_C \leq 125\text{ °C}, D = 1$ |
| | | – | – | 16 | | $T_C \leq 25\text{ °C}, D = 1$ |
| Surge-repetitive forward current, sine halfwave ¹ | $I_{F, RM}$ | – | – | 26 | | $T_C = 25\text{ °C}, t_p = 10\text{ ms}$ |
| Surge non-repetitive forward current, sine halfwave | $I_{F, SM}$ | – | – | 38 | | $T_C = 25\text{ °C}, t_p = 10\text{ ms}$ |
| | | – | – | 30 | | $T_C = 150\text{ °C}, t_p = 10\text{ ms}$ |
| Non-repetitive peak forward current | $I_{F, max}$ | – | – | 410 | | $T_C = 25\text{ °C}, t_p = 10\text{ }\mu\text{s}$ |
| i^2t value | $\int i^2 dt$ | – | – | 7.2 | A ² s | $T_C = 25\text{ °C}, t_p = 10\text{ ms}$ |
| | | – | – | 4.6 | | $T_C = 150\text{ °C}, t_p = 10\text{ ms}$ |
| Repetitive peak reverse voltage | V_{RRM} | – | – | 650 | V | $T_C = 25\text{ °C}$ |
| Diode dv/dt ruggedness | dv/dt | – | – | 150 | V/ns | $V_R = 0..480\text{ V}$ |
| Power dissipation | P_{tot} | – | – | 54 | W | $T_C = 25\text{ °C}, R_{thJC, max}$ |
| Operating and storage temperature | T_j | -55 | – | 175 | °C | – |
| | T_{stg} | | | | | |
| Mounting torque | – | – | – | 70 | Ncm | M3 screw |

2 Thermal characteristics

Table 4 Thermal characteristics (PG-TO-220-2)

| Parameter | Symbol | Values | | | Unit | Note/Test condition |
|--|------------|--------|------|------|------|---------------------------------------|
| | | Min. | Typ. | Max. | | |
| Thermal resistance, junction-case | R_{thJC} | – | 1.7 | 2.8 | K/W | – |
| Thermal resistance, junction-ambient | R_{thJA} | – | – | 62 | | lead |
| Soldering temperature, wavesoldering only allowed at leads | T_{sld} | – | – | 260 | °C | 1.6 mm (0.063 in.) from case for 10 s |

¹ The surge-repetitive forward current test was performed with 1000 pulses (half-wave rectified sine with the 10 ms period).

3 Electrical characteristics

3.1 Static characteristics

Table 5 Static characteristics

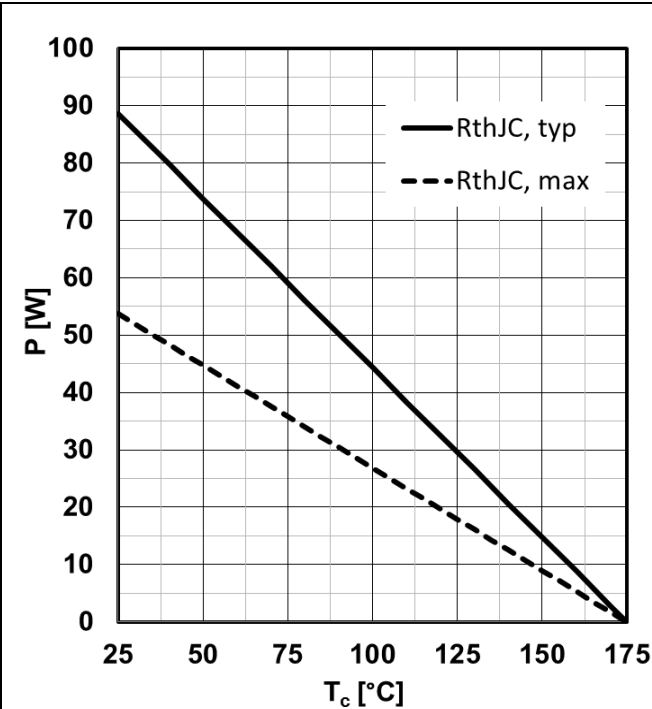
| Parameter | Symbol | Values | | | Unit | Note/Test condition |
|-----------------------|----------|--------|------|------|---------------|---|
| | | Min. | Typ. | Max. | | |
| DC blocking voltage | V_{DC} | 650 | – | – | V | $T_j = 25\text{ °C}$ |
| Diode forward voltage | V_F | – | 1.25 | 1.35 | | $I_F = 6\text{ A}, T_j = 25\text{ °C}$ |
| | | – | 1.5 | – | | $I_F = 6\text{ A}, T_j = 150\text{ °C}$ |
| Reverse current | I_R | – | 0.6 | 20 | μA | $V_R = 420\text{ V}, T_j = 25\text{ °C}$ |
| | | – | 20 | – | | $V_R = 420\text{ V}, T_j = 125\text{ °C}$ |
| | | – | 46 | – | | $V_R = 420\text{ V}, T_j = 150\text{ °C}$ |

3.2 AC characteristics

Table 6 AC characteristics

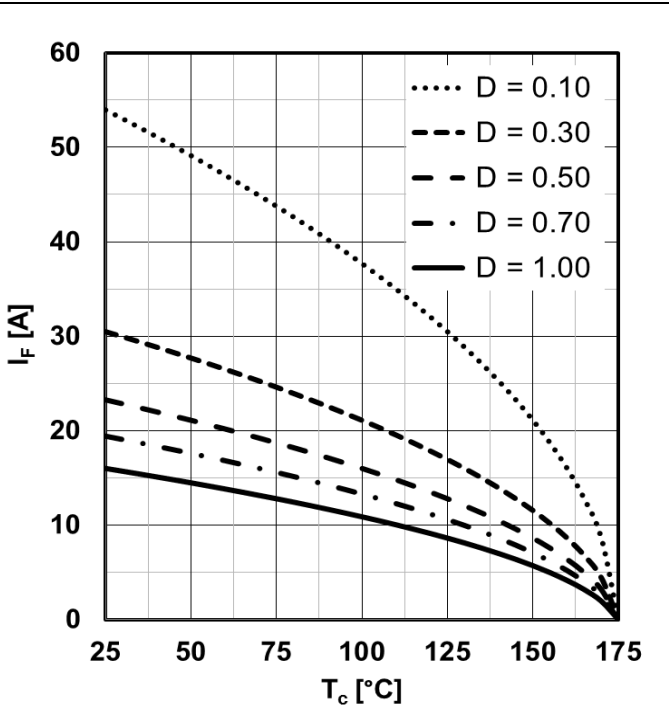
| Parameter | Symbol | Values | | | Unit | Note/Test Condition |
|-------------------------|--------|--------|------|------|------|--|
| | | Min. | Typ. | Max. | | |
| Total capacitive charge | Q_c | – | 9.6 | – | nC | $V_R = 400\text{ V}, T_j = 150\text{ °C},$ $di/dt = 200\text{ A}/\mu\text{s}, I_F \leq I_{F,MAX}$ |
| Total capacitance | C | – | 302 | – | pF | $V_R = 1\text{ V}, f = 1\text{ MHz},$ $T_j = 25\text{ °C}$ |
| | | – | 18 | – | | $V_R = 300\text{ V}, f = 1\text{ MHz},$ $T_j = 25\text{ °C}$ |
| | | – | 17 | – | | $V_R = 600\text{ V}, f = 1\text{ MHz},$ $T_j = 25\text{ °C}$ |

4 Diagrams



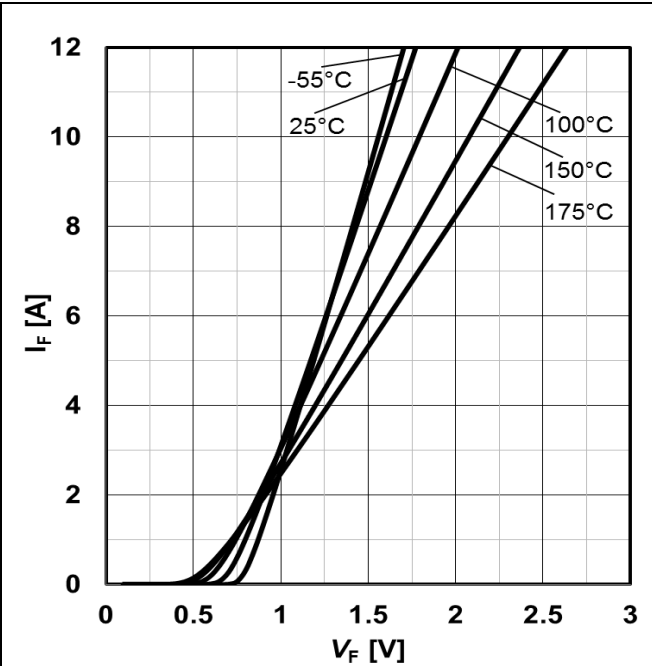
$$P_{tot} = f(T_c)$$

Figure 1 Power dissipation



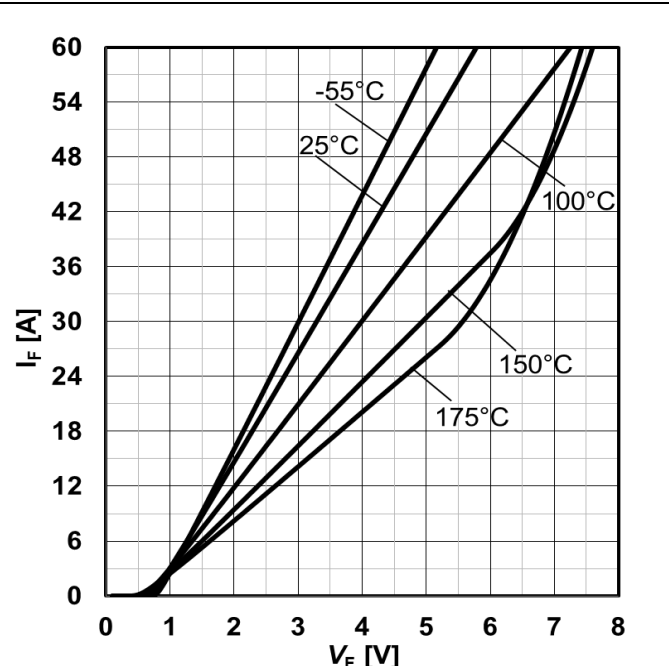
$$I_F = f(T_c); R_{thJC,max}; T_j \leq 175^\circ\text{C}; \text{parameter: } D = t_P/T$$

Figure 2 Max. forward current



$$I_F = f(V_F); t_p = 10 \mu\text{s}; \text{parameter: } T_j$$

Figure 3 Typ. forward characteristics



$$I_F = f(V_F); t_p = 10 \mu\text{s}; \text{parameter: } T_j$$

Figure 4 Typ. forward characteristics
in surge current

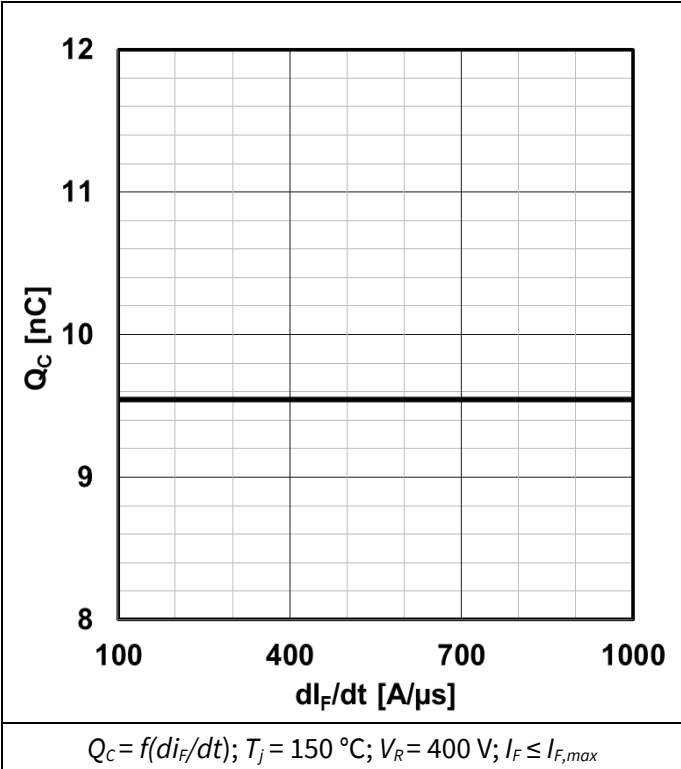


Figure 5 Typ. cap. charge vs. current slope

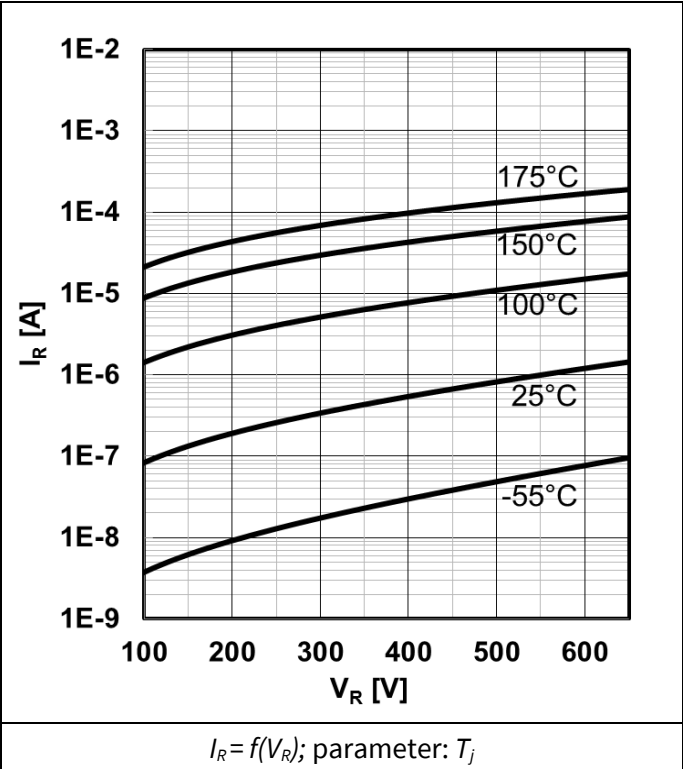


Figure 6 Typ. reverse current vs. reverse voltage

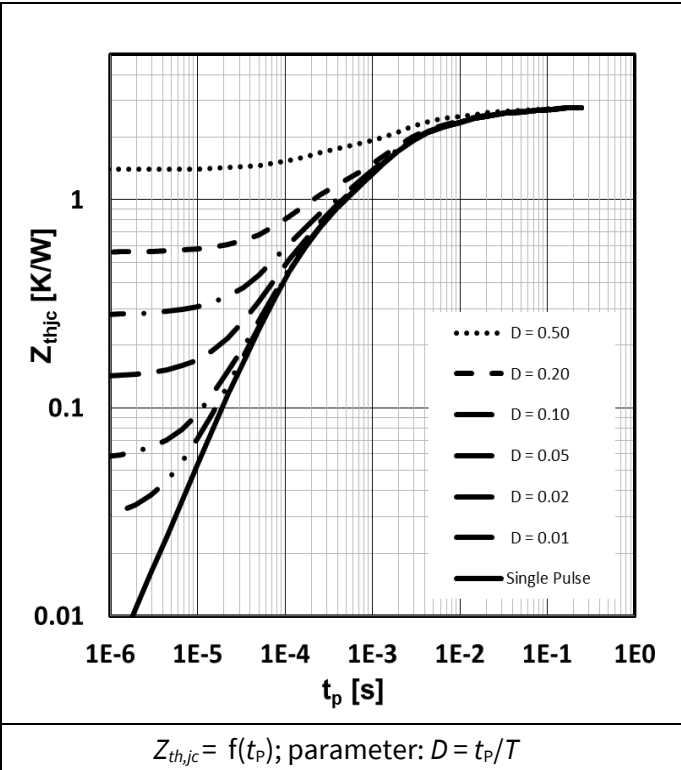


Figure 7 Max. transient thermal impedance

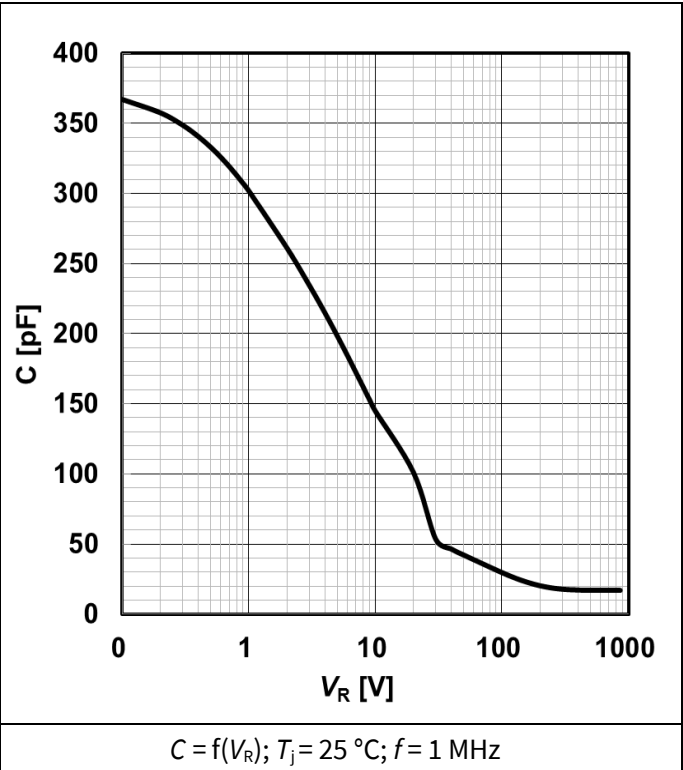


Figure 8 Typ. capacitance vs. reverse voltage

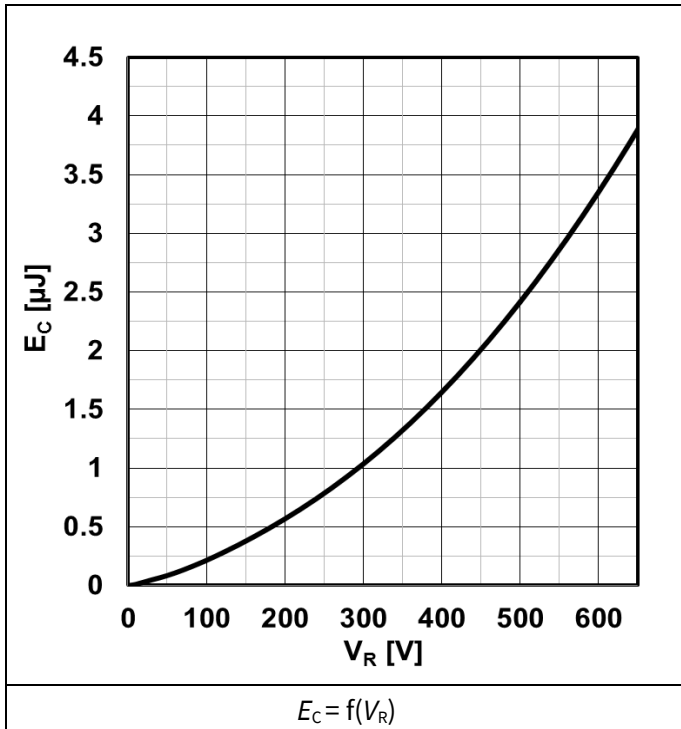


Figure 9 Typ. capacitance stored energy

5 Simplified forward characteristic

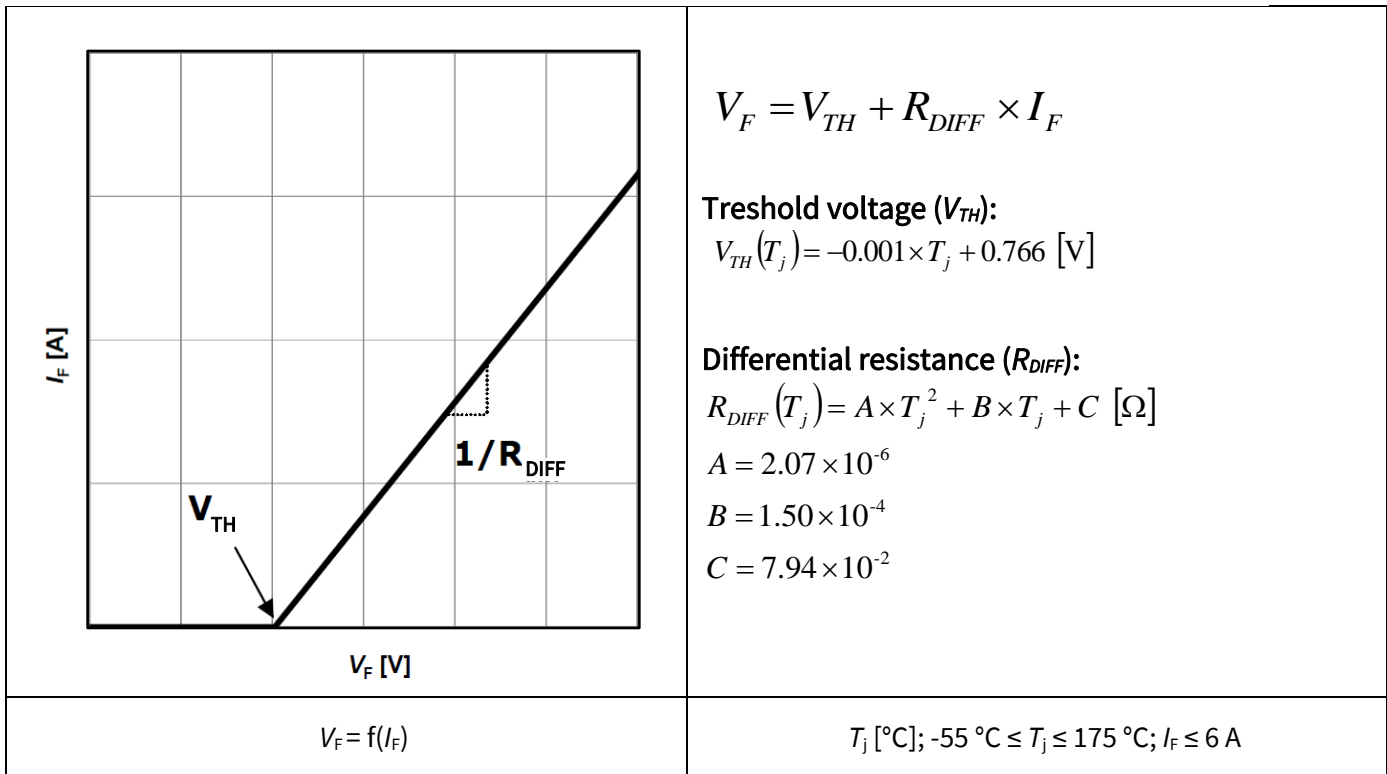


Figure 10 Equivalent forward current curve

Figure 11 Mathematical Equation

6 Package outlines

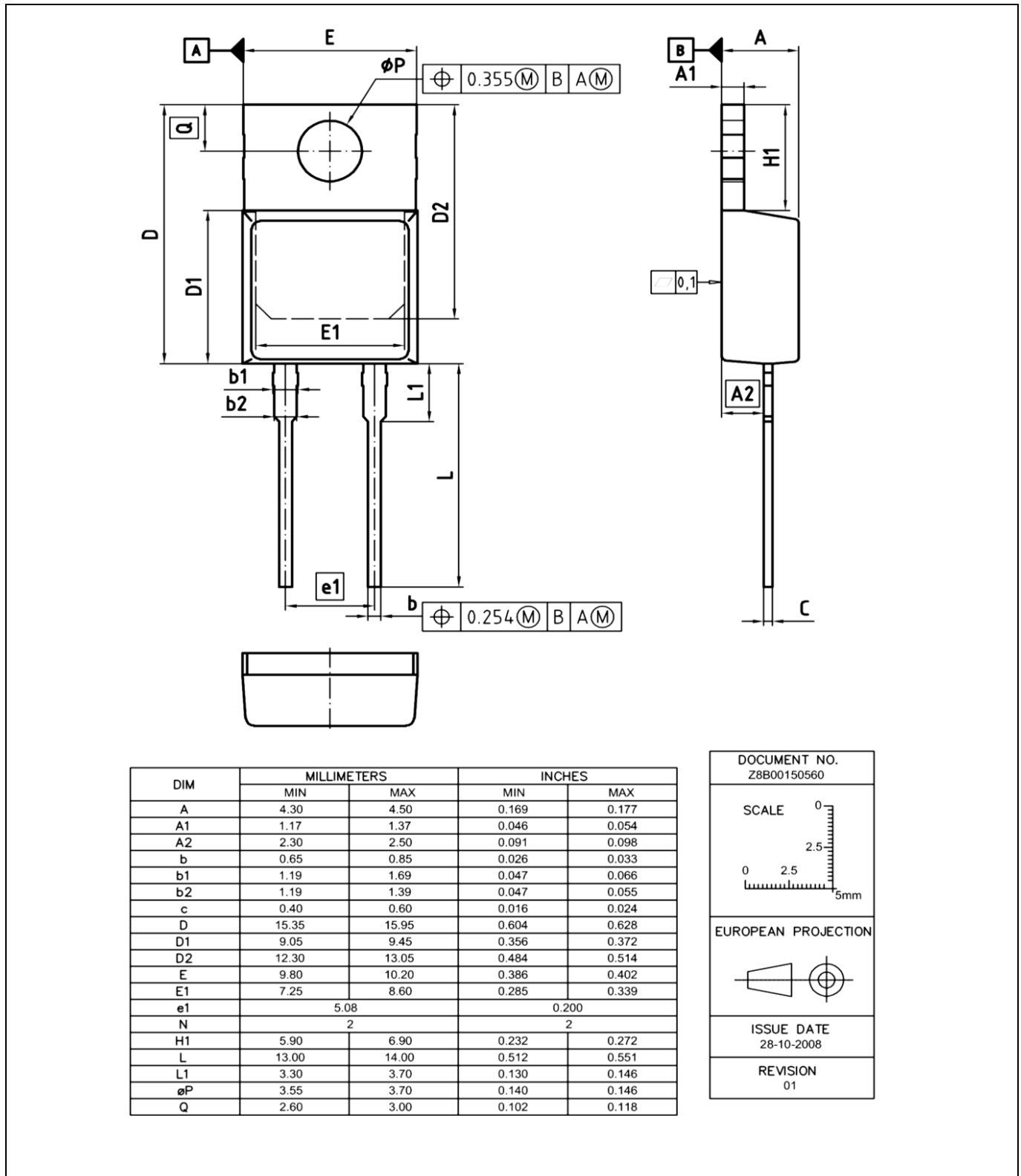


Figure 12 Outlines of the package PG-TO220-2, dimensions in mm/inches

Revision History

Major changes since the last revision

| Revision | Date | Subject (major changes since last revision) |
|----------|------------|---|
| 2.0 | 2017-05-23 | Release of final version |
| | | |
| | | |

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